APPLICA	BLE STAN	IDARD										
	OPERATING TEMPERATURE		RANGE -35°C TO +85°C(NOTE		TEIVII EINATO		RE RANG	_E -1	-10°C TO +60°C(NOTE 3)			
	OPERATING HUMIDITY RANGE		20 % TO 80 % (NC	OTE 2)	HUMID	STORAGE HUMIDITY RANGE		4	40 % TO 70 %(NOTE 3)			
RATING	VOLTAGE		150 V AC	AC CON		LICABLE INECTOR			DF13-*S-1.25C			
	CURRENT		1 A	4 A			DF13(G)-2630S0 MP CONTACT DF13-3032SCF					
			SPEC	SPECIFICATIONS								
П	ГЕМ		TEST METHOD				REQUIREMENTS				АТ	
	RUCTION											
GENERAL EXAMINATION						ACCORDING TO DRAWING.					X	
MARKING	10 0114 0 4	CONFIRMED VISUALLY.							Χ	Χ		
		CTERISTICS 100 m A (DC OR 1000 Hz). 30 mΩ MAX.									1	
CONTACT RESISTANCE INSULATION		, , , , , , , , , , , , , , , , , , ,				30 MΩ MAX. 500 MΩ MIN.				Х	_	
RESISTANCE		100 V BC.				500 MI2 MIN.				Х	_	
VOLTAGE PROOF						NO FLASHOVER OR BREAKDOWN.				Х	_	
MECHANICAL CHARACTERISTICS												
MECHANICAL OPERATION		30 TIMES INSERTIONS AND EXTRACTIONS.				① CONTACT RESISTANCE: 30 mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF				X		
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE				PARTS. ① NO ELECTRICAL DISCONTINUITY OF 1µs.						
		0.75 mm, AT 2 h, FOR 3 DIRECTIONS.				② NO DAMAGE, CRACK OR LOOSENESS OF				Χ	_	
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.				PARTS.				X	_	
ENVIRONMENTAL CHAF											l	
RAPID CHAI								SISTAN	CE: 30mΩ MAX.			
TEMPERATURE						-			ANCE: 500 MΩ MIN.	Х	_	
DAMP HEAT		UNDER 5 CYCLES. EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.				③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.						
(STEADY STATE)		274 332571 1012 3, 30 13 30 73, 30 11.								Χ	_	
RESISTANCE TO		1) REFLOW SOLDERING				NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.				Х		
SOLDERING HEAT		≪REFLOW AREA≫ 250°C MAX 10 sec MAX				LOOSENESS OF THE TERMINALS.					_	
		230°C MIN 60 sec MAX										
		≪PREHEATING AREA≫ 170°C TO 190°C 60 sec TO 120 sec										
		170°C TO 190°C 60 sec TO 120 sec PUT THROUGH IN REFLOW FURNACE TWICE,										
		LEAVE IN AMBIENT TEMPERATURE AND										
		HUMIDITY FOR 1 HOUR. 2) MANUAL SOLDERING										
		SOLDERING IRON TEMPERATURE :350°C,										
		SOLDERING TIME : 3sec.										
SOLDERABILITY		NO STRENGTH ON CONTACT. SOLDERED AT SOLDER TEMPERATURE,				SOLDER SHALL COVER A MINIMUM OF						
		245°C FOR INSERTION DURATION, 3sec.				95 % OF THE SURFACE BEING IMMERSED.				Χ		
REMARKS												
	ODE THE TEMP	ERATURE	RISING BY CURRENT									
NOTE3: APPI	Y TO THE CON		LONG TERM STORAGE FOR U									
	AFTER MOUNTED ON PCB BOARD, OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM STORAGE DURING TRANSPORTATION.											
	TRANSFORTATION.											
COLIN	T DE	DESCRIPTION OF REVISIONS DESIGNATIONS			DECION	SNED CHECKED				D.4.	-	
∆			N OF REVISIONS DESIG			GNED CHECKED			CHECKED	DA	1 =	
Unless otherwise specified			fied, refer to IEC 60512.				APPRO\	/ED	HS.OKAWA	18.0	4.05	
		, . •	•				CHECK		TS.FUKUSHIMA	18.0		
							DESIGN		TS.KUMAZAWA	18.0		
							DRAW	'N	MK.INOUE	18.0		
Note QT:Q	Qualification Te	st AT:As	rance Test X:Applicable Test DF			RAWING NO.			ELC-083662-75-00			
HRS					PART						•	
	J 31							'				

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CODE NO.

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